

### **GENERAL DESCRIPTION**

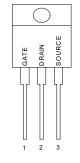
This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

#### **FEATURES**

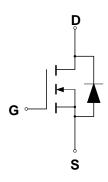
- Robust High Voltage Termination
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- ◆ Diode is Characterized for Use in Bridge Circuits
- I<sub>DSS</sub> Specified at Elevated Temperature

#### PIN CONFIGURATION

TO-220/TO-220FP Front View



## **SYMBOL**



N-Channel MOSFET

## **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain to Current — Continuous	I <sub>D</sub>	7.0	Α
<ul><li>Pulsed</li></ul>	I <sub>DM</sub>	20	
Gate-to-Source Voltage — Continue	$V_{GS}$	±20	V
<ul> <li>Non-repetitive</li> </ul>	$V_{GSM}$	±40	V
Total Power Dissipation	P <sub>D</sub>		W
TO-220		147	
TO-220FP		50	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	$^{\circ}\!\mathbb{C}$
Single Pulse Drain-to-Source Avalanche Energy $-$ T <sub>J</sub> = 25 $^{\circ}$ C	E <sub>AS</sub>	245	mJ
$(V_{DD} = 100V, V_{GS} = 10V, I_L = 7A, L = 10mH, R_G = 25\Omega)$			
Thermal Resistance — Junction to Case	$\theta_{JC}$	1.0	°C/W
Junction to Ambient	$\theta_{JA}$	62.5	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	TL	260	°C

<sup>(1)</sup> Pulse Width and frequency is limited by TJ(max) and thermal response



# **ORDERING INFORMATION**

Part Number	Package		
IRF7N60	TO-220		
IRF7N60FP	TO-220 Full Pak		

## **ELECTRICAL CHARACTERISTICS**

Unless otherwise specified,  $T_J = 25^{\circ}C$ .

Chara	Symbol	Min	Тур	Max	Units	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	600			V	
$(V_{GS} = 0 \text{ V}, I_D = 250 \ \mu \text{ A})$						
Drain-Source Leakage Current		I <sub>DSS</sub>				$\mu A$
$(V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V})$					100	
$(V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C})$					100	
Gate-Source Leakage Current-Forward	I	I <sub>GSSF</sub>			100	nA
$(V_{gsf} = 20 \text{ V}, V_{DS} = 0 \text{ V})$						
Gate-Source Leakage Current-Reverse		I <sub>GSSR</sub>			100	nA
$(V_{gsr} = 20 \text{ V}, V_{DS} = 0 \text{ V})$						
Gate Threshold Voltage		$V_{GS(th)}$	2.0		4.0	V
$(V_{DS} = V_{GS}, I_{D} = 250 \ \mu A)$						
Static Drain-Source On-Resistance (Vo	<sub>SS</sub> = 10 V, I <sub>D</sub> = 3.5A) *	R <sub>DS(on)</sub>			1.2	Ω
Forward Transconductance (V <sub>DS</sub> = 40 \	<b>G</b> FS	4.0			mhos	
nput Capacitance	0/ - 25 V V - 0 V	C <sub>iss</sub>		1380	1800	pF
Output Capacitance	$(V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz)	Coss		115	150	pF
Reverse Transfer Capacitance	1 – 1.0 MHz)	C <sub>rss</sub>		23	30	pF
Turn-On Delay Time	()/ - 200 \/ L - 7.0 A	t <sub>d(on)</sub>		30	70	ns
Rise Time	$(V_{DD} = 300 \text{ V}, I_D = 7.0 \text{ A}, V_{GS} = 10 \text{ V}, R_G = 9.1\Omega) *$	t <sub>r</sub>		80	170	ns
Turn-Off Delay Time		t <sub>d(off)</sub>		125	260	ns
Fall Time	$R_G = 9.1\Omega$ )	t <sub>f</sub>		85	180	ns
Total Gate Charge	0.4 400.4 4 7 0.4	Qg		38	50	nC
Gate-Source Charge	$(V_{DS} = 480 \text{ V}, I_D = 7.0 \text{ A},$	$Q_{gs}$		6.4		nC
Gate-Drain Charge	V <sub>GS</sub> = 10 V)*	$Q_{gd}$		15		nC
Internal Drain Inductance	L <sub>D</sub>		4.5		nH	
(Measured from the drain lead 0.25"	from package to center of die)					
Internal Drain Inductance	Ls		7.5		nH	
(Measured from the source lead 0.25	o" from package to source bond pad)					
SOURCE-DRAIN DIODE CHARACTE	RISTICS					
Forward On-Voltage(1)	/I -7.0 A	V <sub>SD</sub>			1.4	V
Forward Turn-On Time	$(I_S = 7.0 \text{ A},$	t <sub>on</sub>		**		ns
Reverse Recovery Time	$d_{IS}/d_t = 100A/\mu s)$	t <sub>rr</sub>		415		ns

<sup>\*</sup> Pulse Test: Pulse Width  $\leq$ 300 $\mu$ s, Duty Cycle  $\leq$ 2%

<sup>\*\*</sup> Negligible, Dominated by circuit inductance



## TYPICAL ELECTRICAL CHARACTERISTICS

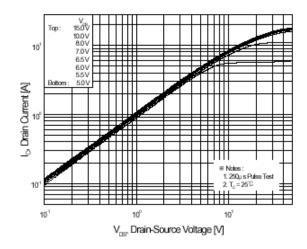


Figure 1. On-Region Characteristics

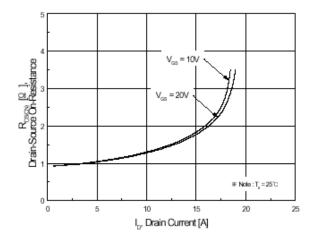


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

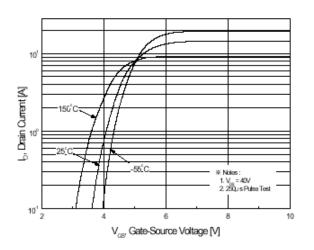


Figure 2. Transfer Characteristics

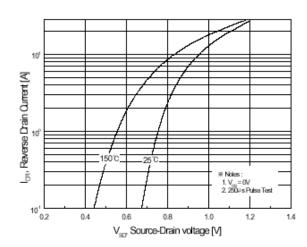


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

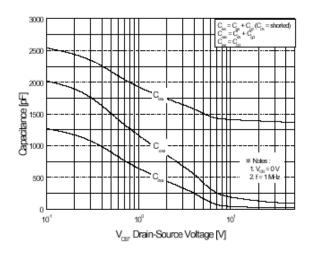


Figure 5. Capacitance Characteristics

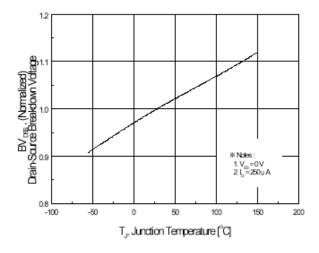


Figure 7. Breakdown Voltage Variation vs Temperature

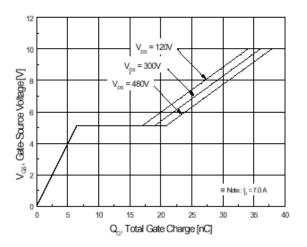


Figure 6. Gate Charge Characteristics

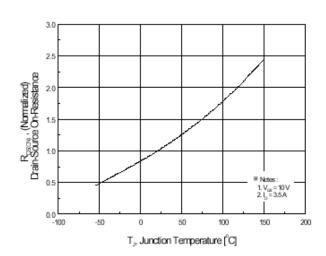
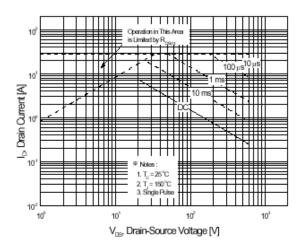


Figure 8. On-Resistance Variation



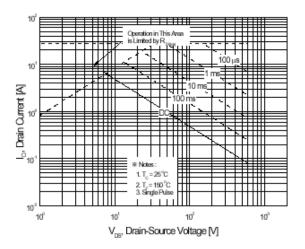


Figure 9-1. Maximum Safe Operating Area

Figure 9-2. Maximum Safe Operating Area

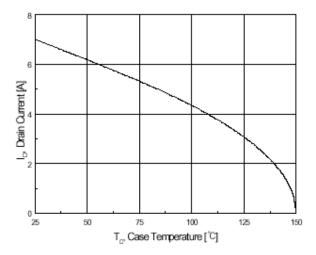
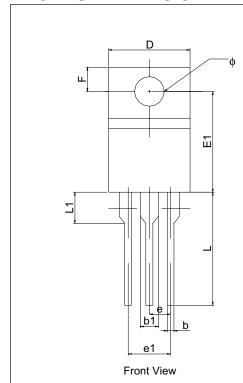


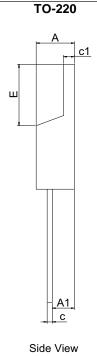
Figure 10. Maximum Drain Current vs Case Temperature





# **PACKAGE DIMENSION**

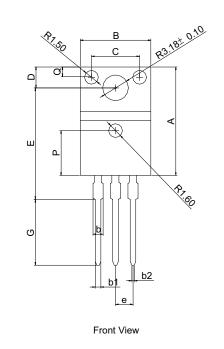


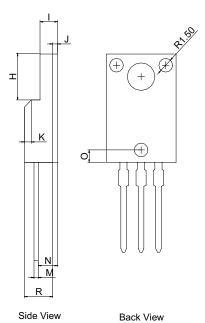


**PIN 1: GATE PIN 2: DRAIN PIN 3: SOURCE** 

	DIMENSIONS IN MILLIMETERS		DIMENSIONS IN INCHS			
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
Α	4.47		4.67	0.176		0.184
A1	2.52		2.82	0.099		0.111
b	0.71		0.91	0.028		0.036
b1	1.17		1.37	0.046		0.054
С	0.31		0.53	0.012		0.021
c1	1.17		1.37	0.046		0.054
D	10.01		10.31	0.394		0.406
E	8.50		8.90	0.335		0.350
E1	12.06		12.46	0.475		0.491
е		2.54			0.100	
e1	4.98		5.18	0.196		0.204
F	2.59		2.89	0.102		0.114
L	13.40		13.80	0.528		0.543
L1	3.56		3.96	0.140		0.156
φ	3.79		3.89	0.149		0.153







SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHS		
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
Α	15.67		16.07	0.617		0.633
В	9.96		10.36	0.392		0.408
С		7.00			0.275	
D	3.20		3.40	0.126		0.134
Е	15.60		16.00	0.614		0.630
G	9.45		10.05	0.372		0.396
н	6.48		6.88	0.255		0.279
- 1	2.34		2.74	0.092		0.108
J		0.70			0.028	
K		1.00			0.039	
м	0.45		0.60	0.018		0.024
N	2.56		2.96	0.101		0.117
0		1.80			0.071	
P		6.50			0.256	
Q		1.50			0.059	
R	4.50		4.90	0.177		0.193
b			1.47			0.058
b1	0.70		0.90	0.028		0.035
b2	0.25		0.45	0.010		0.018
e		2.54			0.100	